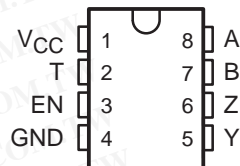
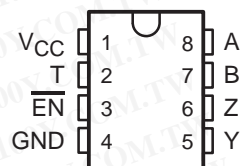


- Meets EIA Standards RS-422-A and RS-485 and CCITT Recommendations V.11 and X.27
- Designed for Multipoint Transmission on Long Bus Lines in Noisy Environments
- 3-State Outputs
- Bus Voltage Range . . . –7 V to 12 V
- Positive and Negative Current Limiting
- Driver Output Capability . . . 60 mA Max
- Driver Thermal Shutdown Protection
- Receiver Input Impedance . . . 12 kΩ Min
- Receiver Input Sensitivity . . . ±200 mV
- Receiver Input Hysteresis . . . 50 mV Typ
- Operates From Single 5-V Supply
- Low Power Requirements

SN75177B . . . D OR P PACKAGE
 (TOP VIEW)



SN75178B . . . P PACKAGE
 (TOP VIEW)



THE SN75177B IS NOT
 RECOMMENDED FOR NEW DESIGN

description

The SN75177B and SN75178B differential bus repeaters are monolithic integrated devices each designed for one-way data communication on multipoint bus transmission lines. These devices are designed for balanced transmission bus line applications and meet EIA Standard RS-422-A and RS-485 and CCITT Recommendations V.11 and X.27. Each device is designed to improve the performance of the data communication over long bus lines. The SN75177B and SN75178B are identical except for the complementary enable inputs, which allow the devices to be used in pairs for bidirectional communication.

The SN75177B and SN75178B feature positive- and negative-current limiting 3-state outputs for the receiver and driver. The receiver features high input impedance, input hysteresis for increased noise immunity, and input sensitivity of ±200 mV over a common-mode input voltage range of –7 V to 12 V. The driver features thermal shutdown for protection from line fault conditions. Thermal shutdown is designed to occur at a junction temperature of approximately 150°C. The driver is designed to drive current loads up to 60 mA maximum.

The SN75177B and SN75178B are designed for optimum performance when used on transmission buses employing the SN75172 and SN75174 differential line drivers, SN75173 and SN75175 differential line receivers, or SN75176B bus transceiver.

Function Tables

SN75177B

DIFFERENTIAL INPUTS A – B	ENABLE EN	OUTPUTS		
		T	Y	Z
$V_{ID} \geq 0.2 V$	H	H	H	L
$-0.2 V < V_{ID} < 0.2 V$	H	?	?	?
$V_{ID} \leq 0.2 V$	H	L	L	H
X	L	Z	Z	Z

SN75178B

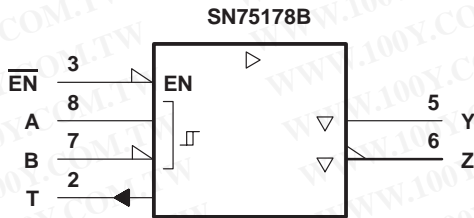
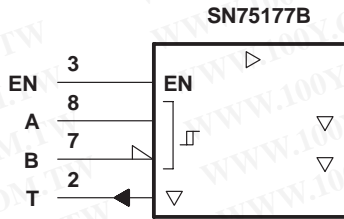
DIFFERENTIAL INPUTS A – B	ENABLE \overline{EN}	OUTPUTS		
		T	Y	Z
$V_{ID} \geq 0.2 V$	L	H	H	L
$-0.2 V < V_{ID} < 0.2 V$	L	?	?	?
$V_{ID} \leq 0.2 V$	L	L	L	H
X	H	Z	Z	Z

H = high level, L = low level, ? = indeterminate, X = irrelevant, Z = impedance (off)

SN75177B, SN75178B DIFFERENTIAL BUS REPEATERS

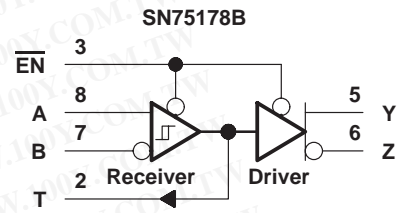
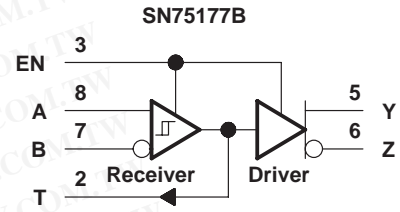
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logic symbols†

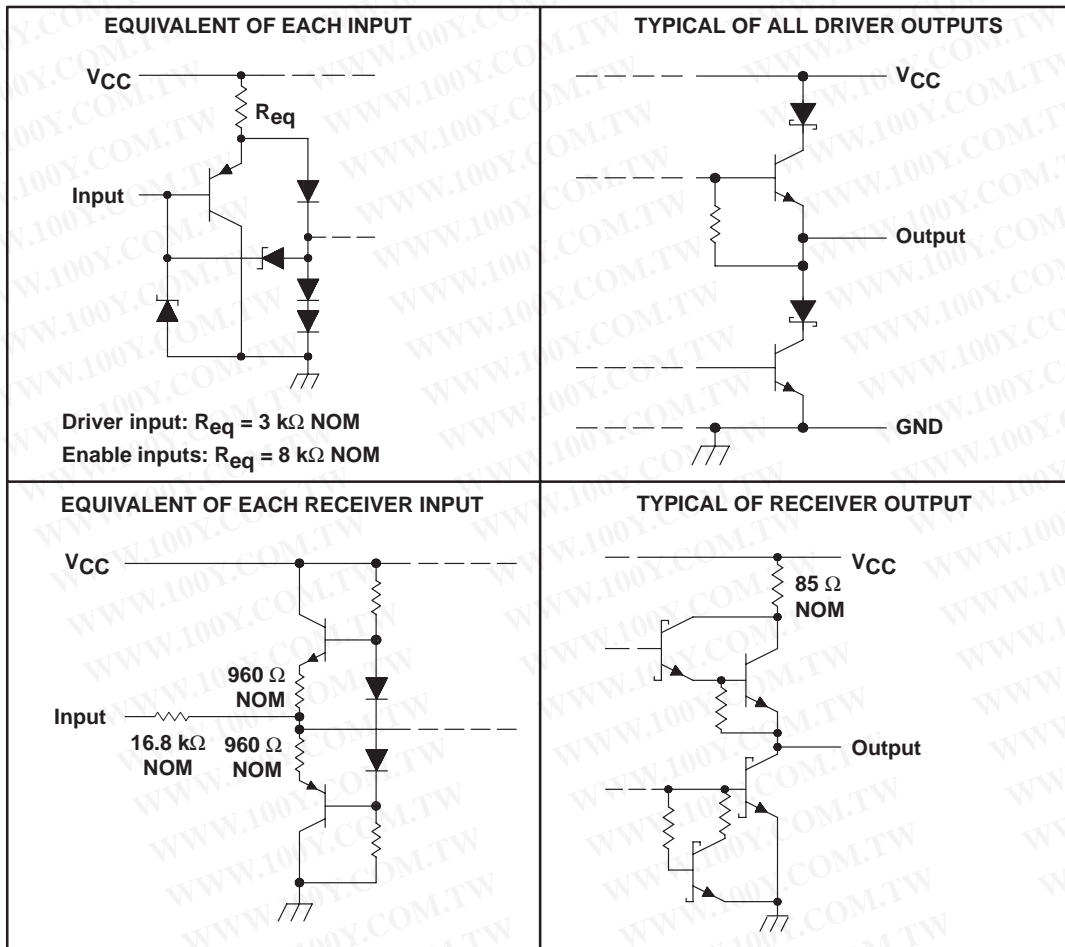


† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagrams (positive logic)



schematics of inputs and outputs



SN75177B, SN75178B DIFFERENTIAL BUS REPEATERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Voltage range at any bus terminal	–10 V to 15 V
Differential input voltage (see Note 2)	± 25 V
Enable input voltage	5.5 V
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range	0°C to 70°C
Storage temperature range	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

- NOTES: 1. All voltage values, except differential input voltage, are with respect to network ground terminal.
 2. Differential input voltage is measured at the noninverting input with respect to the corresponding inverting input.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^{\circ}\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^{\circ}\text{C}$	$T_A = 70^{\circ}\text{C}$ POWER RATING
D	725 mW	5.8 mW/ $^{\circ}\text{C}$	464 mW
P	1000 mW	8.0 mW/ $^{\circ}\text{C}$	640 mW

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}		4.75	5	5.25	V
High-level input voltage, V_{IH}	EN or $\overline{\text{EN}}$	2			V
low-level input voltage, V_{IL}	EN or $\overline{\text{EN}}$			0.8	V
Common-mode input voltage, V_{IC}		-7^{\dagger}		12	V
Differential input voltage, V_{ID}				± 12	V
High-level output current, I_{OH}	Driver			–60	mA
	Receiver			–400	μA
Low-level output current, I_{OL}	Driver			60	mA
	Receiver			8	
Operating free-air temperature, T_A		0		70	$^{\circ}\text{C}$

\dagger The algebraic convention, where the less-positive (more-negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage.

SN75177B, SN75178B DIFFERENTIAL BUS REPEATERS

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DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	UNIT	
V_{IK} Input clamp voltage	$I_I = -18 \text{ mA}$			-1.5	V	
V_O Output voltage	$I_O = 0$	0		6	V	
$ V_{OD1} $ Differential output voltage	$I_O = 0$	1.5		6	V	
$ V_{OD2} $ Differential output voltage	$R_L = 100 \Omega$, See Figure 1	$1/2 V_{OD1}$ or $2 \S$			V	
	$R_L = 54 \Omega$, See Figure 1	1.5	2.5	5		
$ V_{OD3} $ Differential output voltage	See Note 3	1.5		5	V	
$\Delta V_{OD} $ Change in magnitude of differential output voltage‡	$R_L = 54 \Omega$ or 100Ω , See Figure 1			± 0.2	V	
V_{OC} Common-mode output voltage				3 -1	V	
$\Delta V_{OC} $ Change in magnitude of common-mode output voltage‡				± 0.2	V	
I_O Output current	$V_{CC} = 0$, $V_O = -7 \text{ V to } 12 \text{ V}$			± 100	μA	
I_{OZ} High-impedance-state output current	$V_O = -7 \text{ V to } 12 \text{ V}$			± 100	μA	
I_{IH} High-level input current	$V_I = 2.4 \text{ V}$			20	μA	
I_{IL} Low-level input current	$V_I = 0.4 \text{ V}$			-400	μA	
I_{OS} Short-circuit output current	$V_O = -7 \text{ V}$			-250	mA	
	$V_O = V_{CC}$			250		
	$V_O = 12 \text{ V}$			250		
I_{CC} Supply current (total package)	No load	Outputs enabled		57	70	mA
		Outputs disabled		26	35	

† All typical values are at $V_{CC} = 5 \text{ V}$ and $T_A = 25^\circ\text{C}$.

‡ $\Delta|V_{OD}|$ and $\Delta|V_{OC}|$ are the changes in magnitude of V_{OD} and V_{OC} , respectively, that occur when the input is changed from a high level to a low level.

§ The minimum V_{OD2} with a $100\text{-}\Omega$ load is either $1/2 V_{OD1}$ or 2, whichever is greater.

NOTE 3: See Figure 3.5 of EIA Standard RS-485.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{dD} Differential-output delay time	$R_L = 54 \Omega$, See Figure 3		15	20	ns
t_{tD} Differential-output transition time				20	30
t_{PZH} Output enable time to high level	$R_L = 110 \Omega$, See Figure 4		85	120	ns
t_{PZL} Output enable time to low level	$R_L = 110 \Omega$, See Figure 5		40	60	ns
t_{PHZ} Output disable time from high level	$R_L = 110 \Omega$, See Figure 4		150	250	ns
t_{PLZ} Output disable time from low level	$R_L = 110 \Omega$, See Figure 5		20	30	ns

SN75177B, SN75178B DIFFERENTIAL BUS REPEATERS

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PARAMETER MEASUREMENT INFORMATION

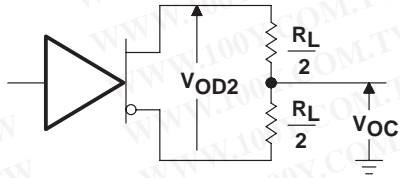


Figure 1. Driver V_{OD} and V_{OC}

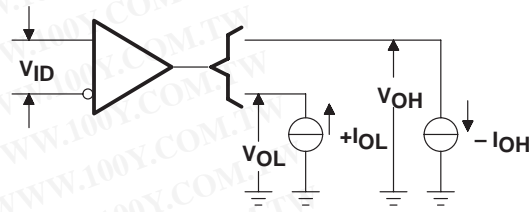
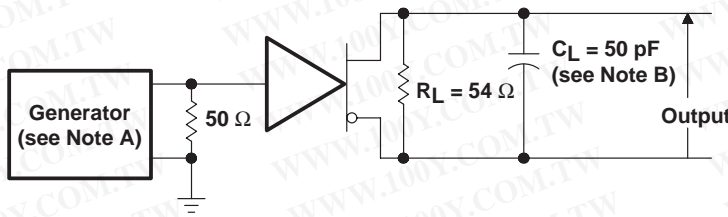
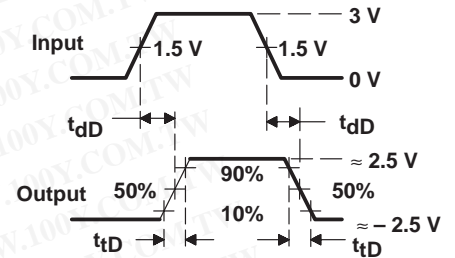


Figure 2. Receiver V_{OH} and V_{OL}

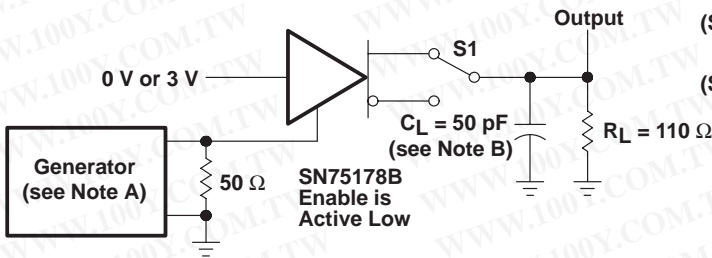


TEST CIRCUIT

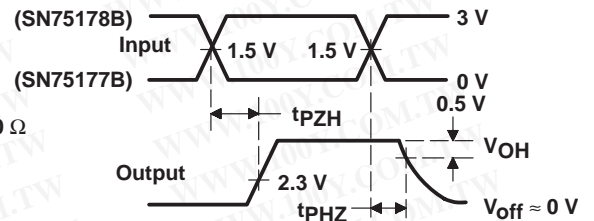


VOLTAGE WAVEFORMS

Figure 3. Driver Differential-Output Test Circuit and Voltage Waveforms

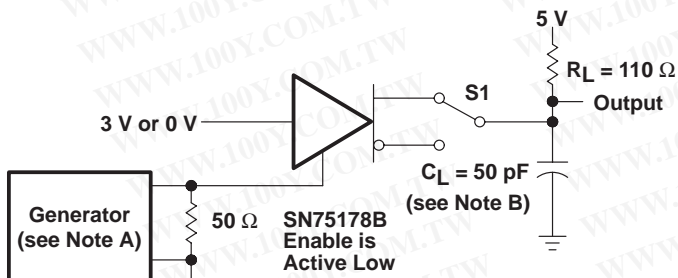


TEST CIRCUIT

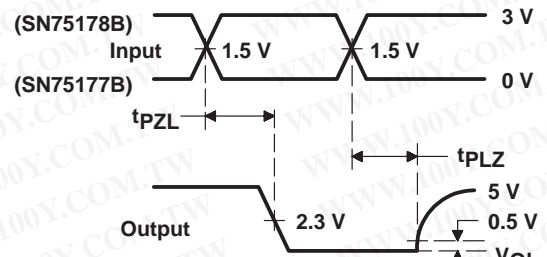


VOLTAGE WAVEFORMS

Figure 4. Driver Enable and Disable Times



TEST CIRCUIT



VOLTAGE WAVEFORMS

Figure 5. Driver Enable and Disable Times

NOTES: A. The input pulse is supplied by a generator having the following characteristics: $PRR \leq 1$ MHz, 50% duty cycle, $t_r \leq 6$ ns, $t_f \leq 6$ ns, $Z_0 = 50 \Omega$.

B. C_L includes probe and jig capacitance.

PARAMETER MEASUREMENT INFORMATION

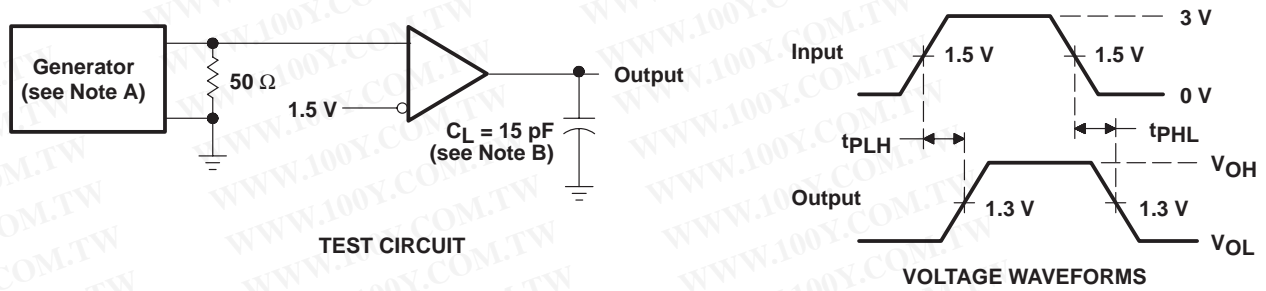


Figure 6. Receiver Propagation Delay Times

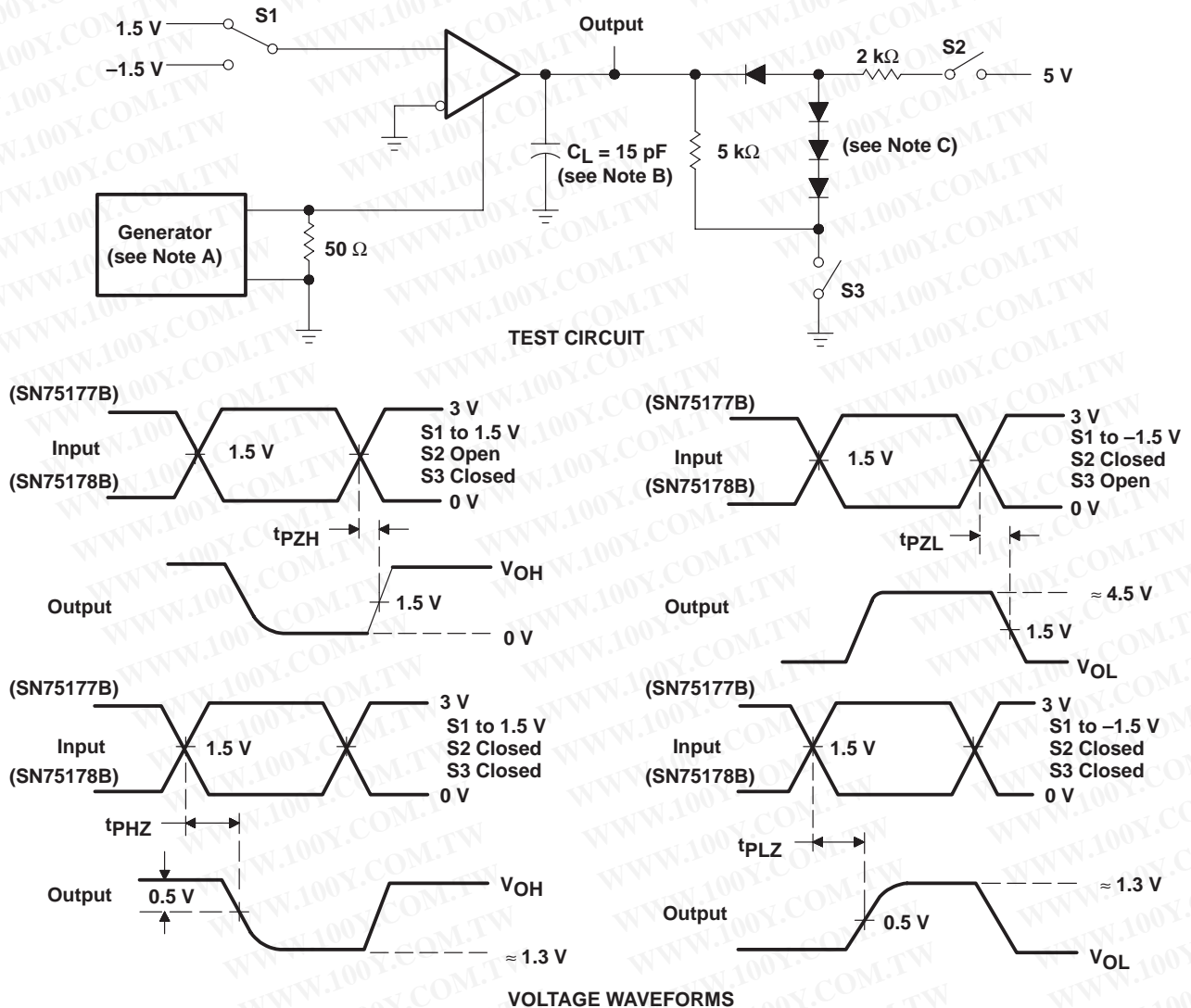


Figure 7. Receiver Output Enable and Disable Times

- NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_r \leq$ 6 ns, $t_f \leq$ 6 ns, $Z_0 = 50 \Omega$.
 B. C_L includes probe and jig capacitance.
 C. All diodes are 1N916 or equivalent.

SN75177B, SN75178B DIFFERENTIAL BUS REPEATERS

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TYPICAL CHARACTERISTICS

**DRIVER HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT**

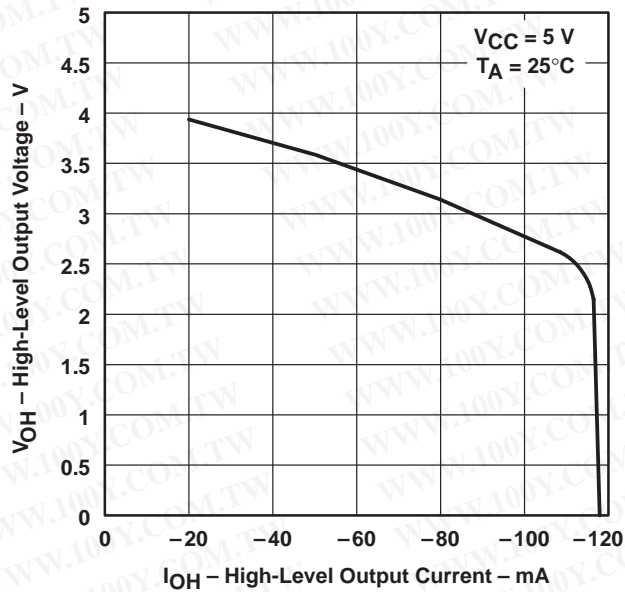


Figure 8

**DRIVER LOW-LEVEL OUTPUT VOLTAGE
vs
LOW-LEVEL OUTPUT CURRENT**

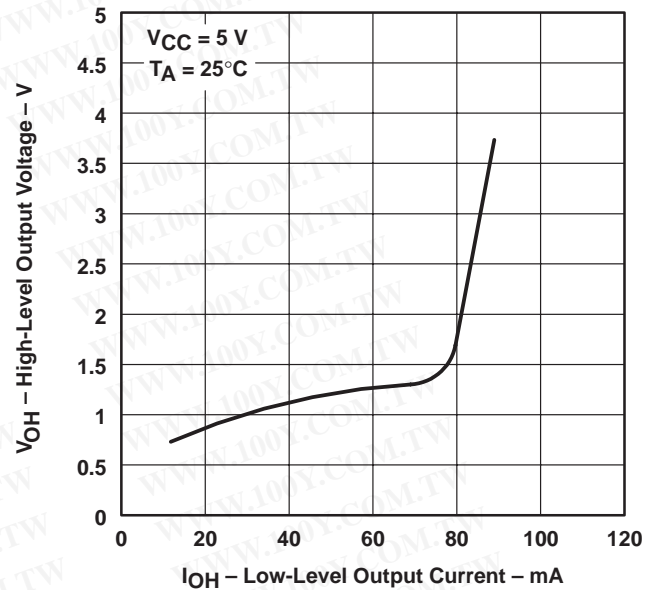


Figure 9

**DRIVER DIFFERENTIAL OUTPUT VOLTAGE
vs
DRIVER OUTPUT CURRENT**

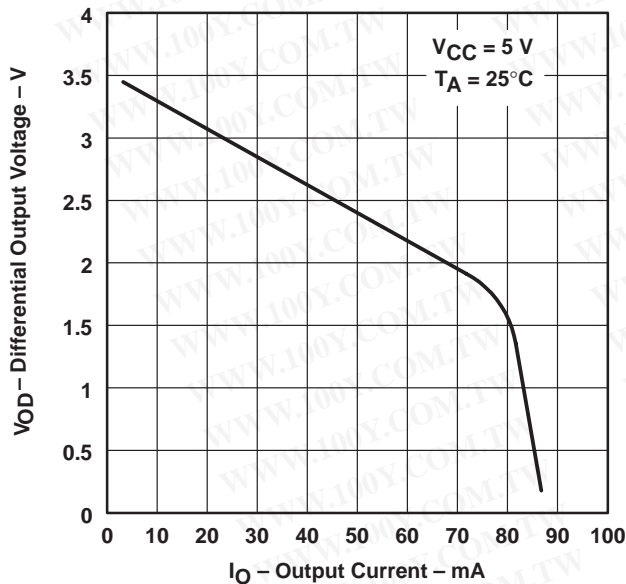


Figure 10

**RECEIVER OUTPUT VOLTAGE
vs
DIFFERENTIAL INPUT VOLTAGE**

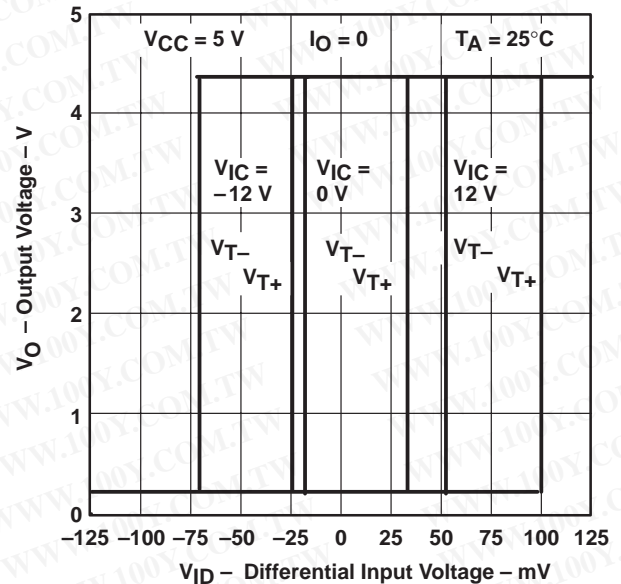


Figure 11

TYPICAL CHARACTERISTICS

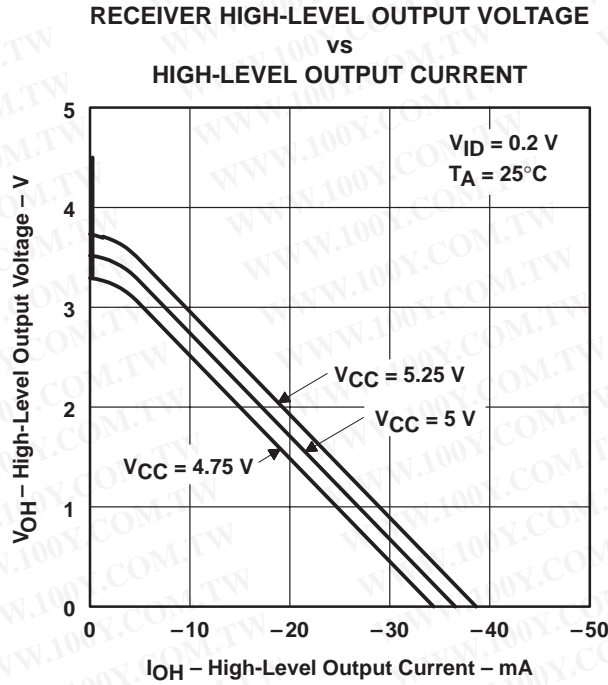


Figure 12

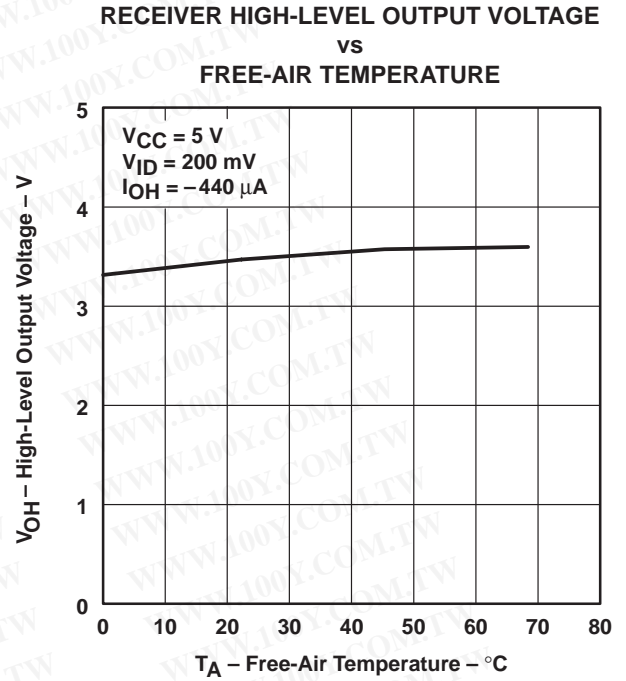


Figure 13

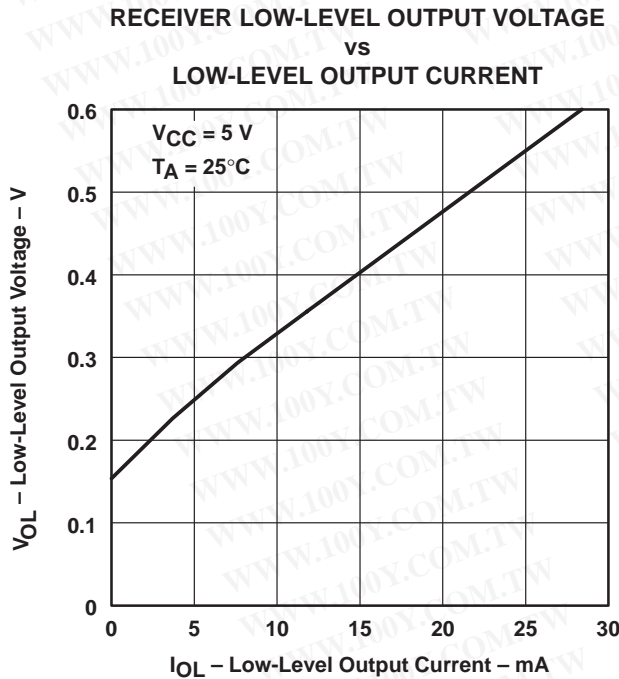


Figure 14

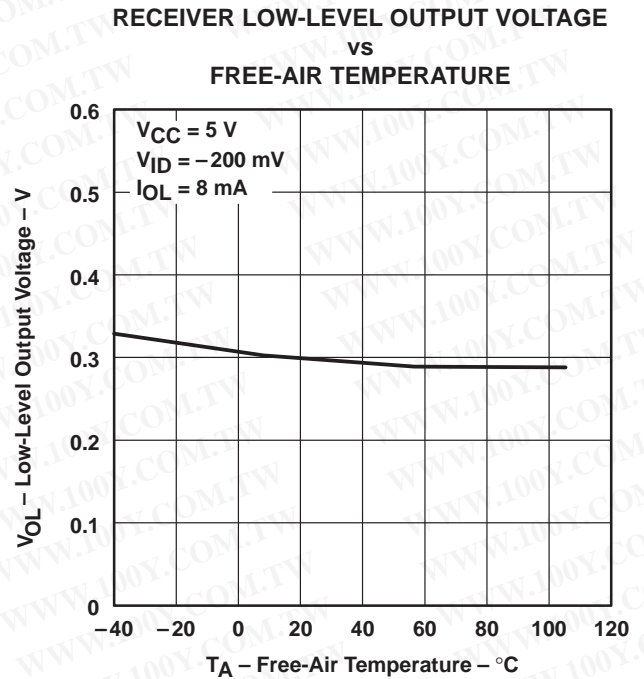
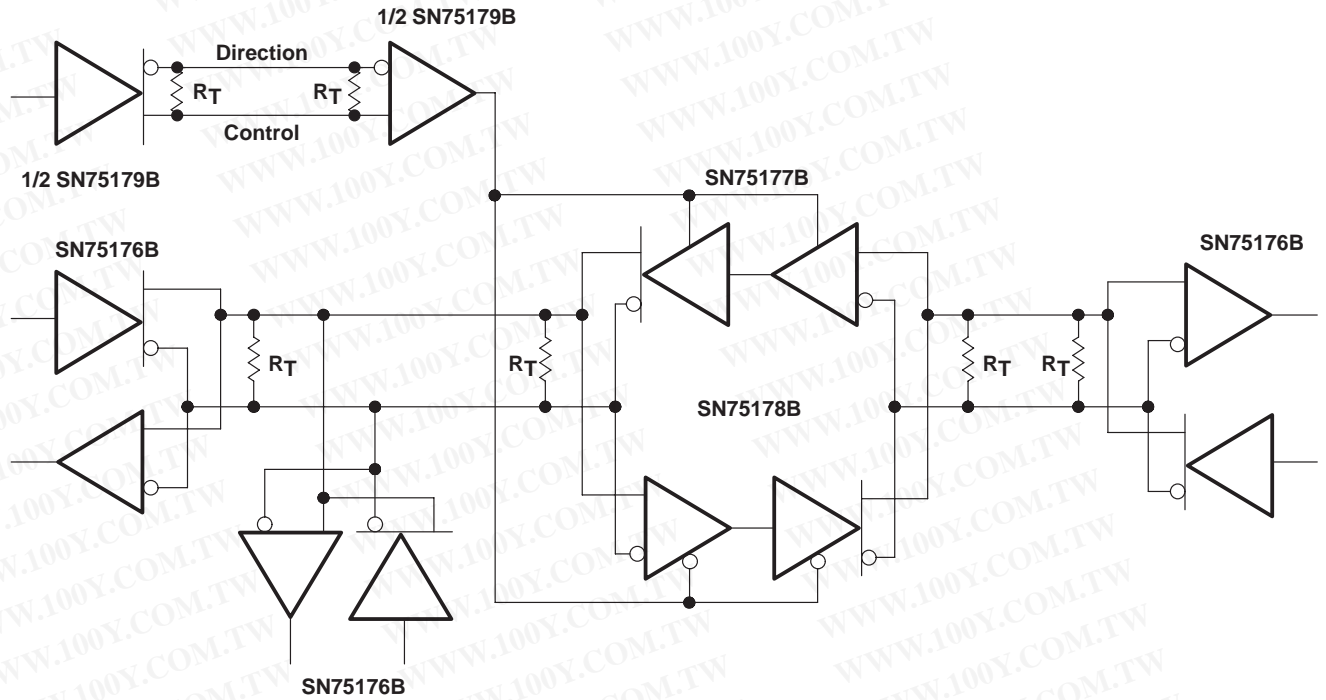


Figure 15

SN75177B, SN75178B DIFFERENTIAL BUS REPEATERS

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APPLICATION INFORMATION



NOTE: The line should be terminated at both ends in its characteristic impedance. Stub lengths off the main line should be kept as short as possible.

Figure 16. Typical Application Circuit

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SN75177BD	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	Samples Not Available
SN75177BP	OBSOLETE	PDIP	P	8		TBD	Call TI	Call TI	Samples Not Available
SN75178BD	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	Samples Not Available
SN75178BDR	OBSOLETE	SOIC	D	8		TBD	Call TI	Call TI	Samples Not Available
SN75178BP	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Contact TI Distributor or Sales Office
SN75178BPE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Contact TI Distributor or Sales Office

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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